

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Katsuji SHIBATA et al.

Group Art Unit : 1754

Appl. No. : 10/088,531

Examiner : Ardith E. HERTZOG

Filed : May 31, 2002

Confirmation No. : 9253

For : METHOD OF TREATING EPOXY RESIN-CURED PRODUCT

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
U.S. Patent and Trademark Office
220 20th Street S.
Customer Window, Mail Stop _____
Crystal Plaza Two, Lobby, Room 1B03
Arlington, VA 22202

Sir :

In accordance with the duty of disclosure under 37 C.F.R. §1.56 and §§1.97-1.98 and supplemental to the Information Disclosure Statements that were filed on November 9, 2004, July 12, 2004, and July 2, 2002, Applicants hereby call to the Examiner's attention the following documents:

Japanese Laid-Open Patent Publication No. HEI 8-325436, together with a full English language machine translation of the same. Applicants note that an English language Abstract of this document was previously submitted together with the Information Disclosure Statement of July 2, 2002;

Japanese Laid-Open Patent Publication No. HEI 8-325437, together with a full English language machine translation of the same. Applicants note that an

English language Abstract of this document was previously submitted together with the Information Disclosure Statement of July 2, 2002;

Japanese Laid-Open Patent Publication No. HEI 8-325438, together with a full English language machine translation of the same. Applicants note that an English language Abstract of this document was previously submitted together with the Information Disclosure Statement of July 2, 2002;

Japanese Laid-Open Patent Publication No. HEI 9-316445, together with a full English language machine translation of the same. Applicants note that an English language Abstract of this document was previously submitted together with the Information Disclosure Statement of July 2, 2002; and

Japanese Laid-Open Patent Publication No. HEI 10-126052, together with a full English language machine translation of the same. Applicants note that an English language Abstract of this document was previously submitted together with the Information Disclosure Statement of July 2, 2002.

Applicants respectfully request that the Examiner consider the above material and cite the same. Copies of the above-noted foreign documents are attached hereto and all of the documents are listed on the attached PTO-1449 Form. The Examiner is requested to initial the appropriate spaces on the attached Form and to return a copy of the completed Form to Applicants with the next official communication in the present application.

Further, Applicants note that since this Supplemental Information Disclosure Statement is being submitted subsequent to the issuance of an Office Action on the merits, Applicants have included herewith a check in the amount of

\$180.00 to cover the fee set forth in 37 C.F.R. §1.17 (p). However, the Commissioner is hereby authorized to charge payment of any necessary additional fees associated with this communication or credit any overpayment to Deposit Account No. 19-0089.

Should the Examiner have any questions, the Examiner is invited to contact the undersigned at the below-listed telephone number.

Respectfully Submitted,
Katsuji SHIBATA et al.



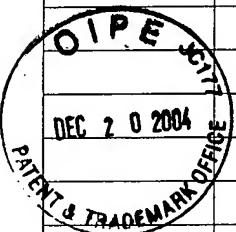
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FORM PTO-1449	U.S. Department of Commerce Patent and Trademark Office	Atty. Docket No. P22180	Application No. 10/088,531
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary)		Applicant Katsuji SHIBATA et al.	
		Filing Date May 31, 2002	Group 1754

U.S. PATENT DOCUMENTS



FOREIGN PATENT DOCUMENTS

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

EXAMINER

DATE CONSIDERED

*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.